

Status

MLP2012H2R2MT0S1

Applications

Commercial Grade

Feature

Multilayer

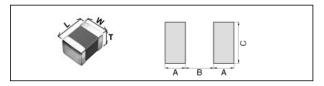
Shield

Magnetic Shield

Ferrite Core

Series

MLP Series / MLP2012 Type



Production









Size	
Length(L)	2.00mm +/-0.20mm
Width(W)	1.25mm +/-0.20mm
Thickness(T)	0.85mm +/-0.15mm
Recommended Land Pattern (A)	0.80mm Nom.
Recommended Land Pattern (B)	1.00mm Nom.
Recommended Land Pattern (C)	1.20mm Nom.

Electrical Characteristics	
Inductance	2.2uH +/-20% at 2MHz
Rated Current (Temperature Rise) [Max.]	1A (40degC Rise)
DC Resistance [Nom.]	150mΩ
DC Resistance [Max.]	195mΩ

Other		
Operating Temp. Range (Including Self-Temp. Rise)	-40 to 125degC	
Soldering Method	Reflow, Iron Soldering	
AEC Q200	No	
Packing	Punched (Paper)Taping [180mm Reel]	
Package Quantity	4000Pcs Min.	
Weight	0.01g	

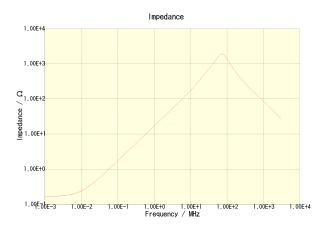
[•]This PDF document was created based on the data listed on the TDK Corporation website.

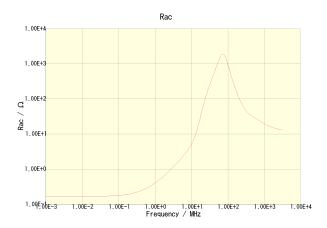
[•]All specifications are subject to change without notice.



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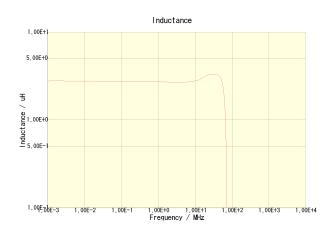
Characteristic Graphs (This is reference data, and does not guarantee the product's characteristics.)

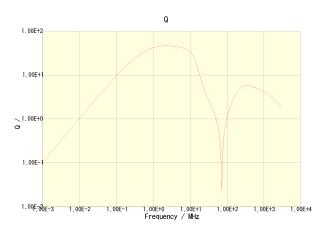




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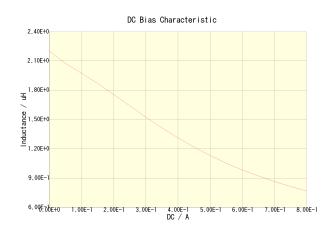
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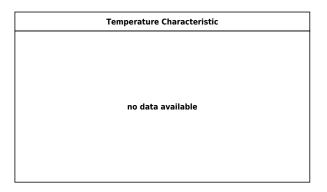
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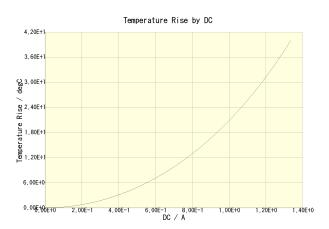
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MLP2012H2R2MT0S1(Amb. Temp. = 20degc)



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